Silicon P-Channel MOS FET

# HITACHI

ADE-208-143 1st. Edition

#### Application

Low frequency power amplifier

Complementary pair with 2SK2220, 2SK2221

#### Features

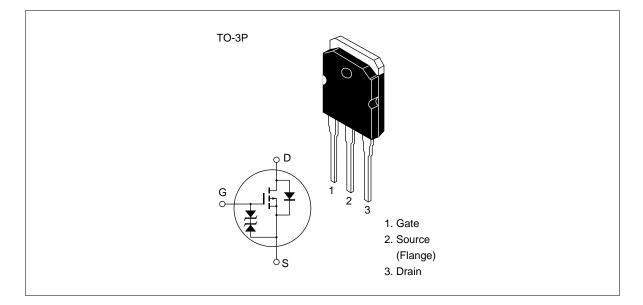
- High power gain
- Excellent frequency response
- High speed switching
- Wide area of safe operation
- Enhancement-mode
- Good complementary characteristics
- Equipped with gate protection diodes

#### **Ordering Information**

| Type No. | V <sub>DSX</sub> |
|----------|------------------|
| 2SJ351   | –180 V           |
| 2SJ352   | –200 V           |



#### Outline



### **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

|                 | Symbol             | Ratings  | Unit   |
|-----------------|--------------------|--|--|
| 2SJ351          | V <sub>DSX</sub>   | -180   | V  |
| 2SJ352          |                    | -200   |  |
|                 | V <sub>GSS</sub>   | ±20  | V  |
|                 | I <sub>D</sub>     | -8   | A  |
| e drain current | I <sub>DR</sub> —8 |  | А  |
|                 | Pch*1              | 100  | W  |
|                 | Tch                | 150  | °C   |
|                 | Tstg               | -55 to +150  | °C   |
|                 | 2SJ352             | $\frac{2SJ351}{2SJ352} V_{DSX}$ $\frac{V_{GSS}}{I_D}$ e drain current $I_{DR}$ Pch*1 Tch | $ \frac{2SJ351}{2SJ352} V_{DSX} -180 \\ -200 \\ V_{GSS} \pm 20 \\ I_D -8 \\ e drain current I_{DR} -8 \\ Pch^{*1} 100 \\ Tch 150 $ |

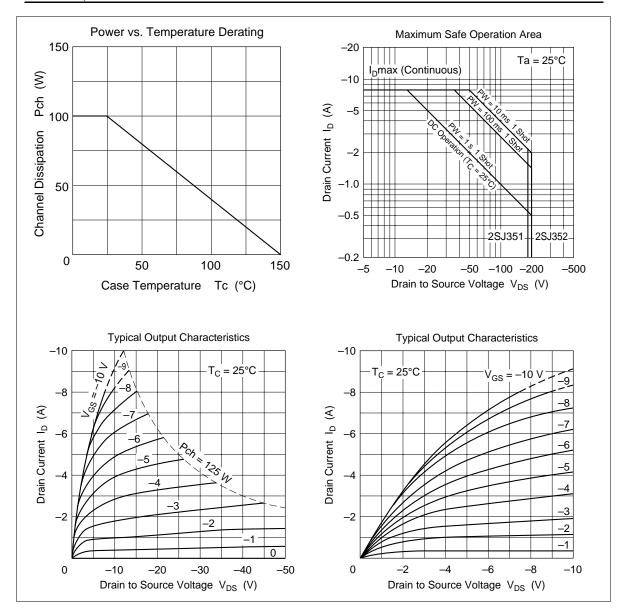
Note: 1. Value at  $T_c = 25^{\circ}C$ 

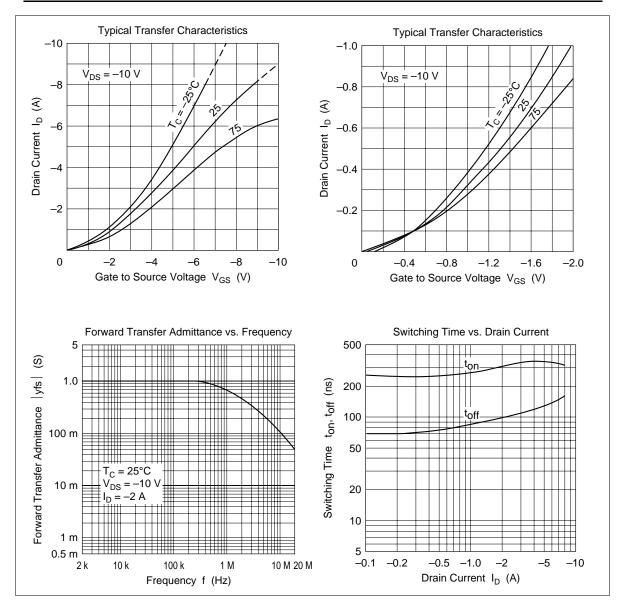
#### **Electrical Characteristics** (Ta = 25°C)

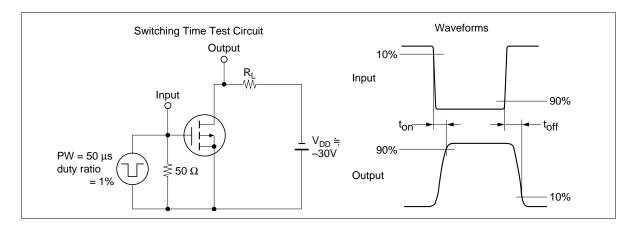
| Item                               |        | Symbol                      | Min   | Тур  | Max   | Unit | Test conditions   |
|------------------------------------|--------|-----------------------------|-------|------|-------|------|---|
| Drain to source                    | 2SJ351 | $V_{(BR)DSX}$               | -180  | —    | _     | V    | $I_{\rm D} = -10$ mA, $V_{\rm GS} = 10$ V                 |
| breakdown voltage                  | 2SJ352 |                             | -200  | _    | _     |      |   |
| Gate to source breakdown voltage   |        | $V_{(\text{BR})\text{GSS}}$ | ±20   | _    | _     | V    | $I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$                   |
| Gate to source cutoff voltage      |        | $V_{GS(off)}$               | -0.15 | —    | -1.45 | V    | $I_{\rm D} = -100 \text{ mA}, V_{\rm DS} = -10 \text{ V}$ |
| Drain to source saturation voltage |        | $V_{\text{DS(sat)}}$        | _     | _    | -12   | V    | $I_{\rm D} = -8$ A, $V_{\rm GD} = 0^{*1}$                 |
| Forward transfer admittance        |        | y <sub>fs</sub>             | 0.7   | 1.0  | 1.4   | S    | $I_{\rm D} = -3$ A, $V_{\rm DS} = -10$ V <sup>*1</sup>    |
| Input capacitance                  |        | Ciss                        | —     | 800  | _     | pF   | $V_{GS} = 5 \text{ V}, V_{DS} = -10 \text{ V},$           |
| Output capacitance                 |        | Coss                        | —     | 1000 | _     | pF   | f = 1 MHz   |
| Reverse transfer capacitance       |        | Crss                        | —     | 18   | —     | pF   |   |
| Turn-on time                       |        | t <sub>on</sub>             | _     | 320  | _     | ns   | $V_{\rm DD} = -30$ V, $I_{\rm D} = -4$ A                  |
| Turn-off time                      |        | t <sub>off</sub>            | _     | 120  | —     | ns   |   |
|                                    |        |                             |       |      |       |      |   |

Note: 1. Pulse test

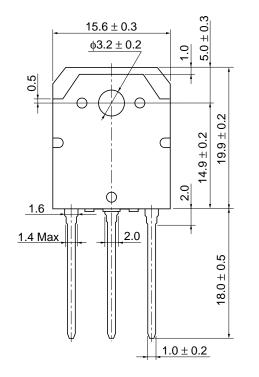
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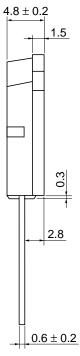






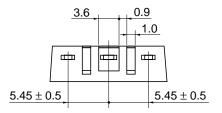
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Unit: mm



| Hitachi Code             | TO-3P    |
|--------------------------|----------|
| JEDEC                    | —        |
| EIAJ                     | Conforms |
| Weight (reference value) | 5.0 g    |

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